Quad Digitally Controlled Potentiometers (XDCP™)

Data Sheet December 17, 2007 FN6624.0

Low Noise, Low Power I²C® Bus, 128 Taps

The ISL22346WMVEP integrates four digitally controlled potentiometers (DCP) and non-volatile memory on a monolithic CMOS integrated circuit.

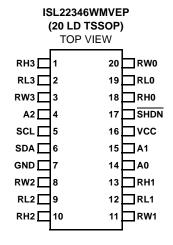
The digitally controlled potentiometers are implemented with a combination of resistor elements and CMOS switches. The position of the wipers are controlled by the user through the I²C bus interface. Each potentiometer has an associated volatile Wiper Register (WR) and a non-volatile Initial Value Register (IVR) that can be directly written to and read by the user. The contents of the WR controls the position of the wiper. At power-up, the device recalls the contents of the two DCP's IVR to the corresponding WRs.

The DCPs can be used as a three-terminal potentiometers or as a two-terminal variable resistors in a wide variety of applications including control, parameter adjustments and signal processing.

Device Information

The specifications for an Enhanced Product (EP) device are defined in a Vendor Item Drawing (VID), which is controlled by the Defense Supply Center in Columbus (DSCC). "Hot-links" to the applicable VID and other supporting application information are provided on our website.

Pinout



Features

- Specifications per DSCC VID V62/08605-01XE
- Full Mil-Temp Electrical Performance from -55°C to +125°C
- Controlled Baseline with One Wafer Fabrication Site and One Assembly/Test Site
- · Full Homogeneous Lot Processing in Wafer Fab
- No Combination of Wafer Fabrication Lots in Assembly
- Full Traceability Through Assembly and Test by Date/Trace Code Assignment
- Enhanced Process Change Notification
- Enhanced Obsolescence Management
- Eliminates Need for Up-Screening a COTS Component
- · Four Potentiometers in One Package
- 128 Resistor Taps
- I²C Serial Interface
 - Three Address Pins, Up To Eight Devices/Bus
- Non-volatile Storage of Wiper Position
- Wiper Resistance: 70Ω Typical @ 3.3V
- Shutdown Mode
- Shutdown Current 5µA Max
- Power Supply: 2.7V to 5.5V
- 10kΩ Total Resistance
- High Reliability
 - Endurance: 1,000,000 Data Changes Per Bit Per Register
 - Register Data Retention:
 - 10 years @ T ≤ +125°C
 - 15 years @ T ≤ +90°C
 - 50 years @ T ≤ +55°C
- 20 Ld TSSOP

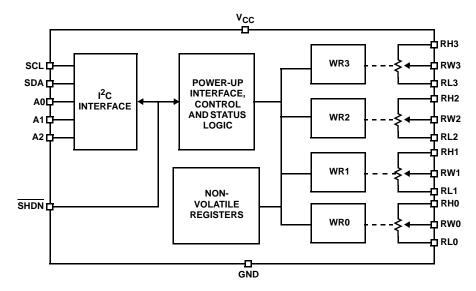
Ordering Information

| VENDOR PART NUMBER (Notes 1, 2) | VENDOR ITEM DRAWING | PART MARKING | RESISTANCE OPTION ($k\Omega$) | TEMP. RANGE (°C) | PACKAGE | PKG. DWG. # |
|------------------------------------|---------------------|--------------|---------------------------------|---------------------|-------------|----------------|
| ISL22346WMVEP | V62/08605-01XE | 22346 WMVEP | 10 | -55 to +125 | 20 Ld TSSOP | M20.173 |

NOTES:

- 1. Add "-TK" suffix for tape and reel. Please refer to TB347 for details on reel specifications.
- 2. Devices must be procured to the VENDOR PART NUMBER.

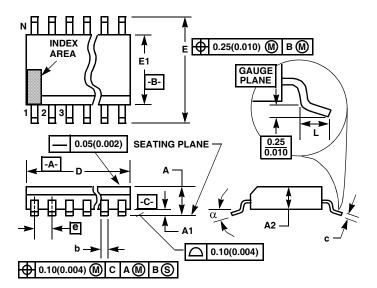
Block Diagram



Pin Descriptions

| TSSOP PIN | SYMBOL | DESCRIPTION | |
|-----------|--------|---|--|
| 1 | RH3 | "High" terminal of DCP3 | |
| 2 | RL3 | "Low" terminal of DCP3 | |
| 3 | RW3 | "Wiper" terminal of DCP3 | |
| 4 | A2 | Device address input for the I ² C interface | |
| 5 | SCL | Open drain I ² C interface clock input | |
| 6 | SDA | Open drain Serial data I/O for the I ² C interface | |
| 7 | GND | Device ground pin | |
| 8 | RW2 | "Wiper" terminal of DCP2 | |
| 9 | RL2 | "Low" terminal of DCP2 | |
| 10 | RH2 | "High" terminal of DCP2 | |
| 11 | RW1 | "Wiper" terminal of DCP1 | |
| 12 | RL1 | "Low" terminal of DCP1 | |
| 13 | RH1 | "High" terminal of DCP1 | |
| 14 | A0 | Device address input for the I ² C interface | |
| 15 | A1 | Device address input for the I ² C interface | |
| 16 | VCC | Power supply pin | |
| 17 | SHDN | Shutdown active low input | |
| 18 | RH0 | "High" terminal of DCP0 | |
| 19 | RL0 | "Low" terminal of DCP0 | |
| 20 | RW0 | "Wiper" terminal of DCP0 | |

Thin Shrink Small Outline Plastic Packages (TSSOP)



NOTES:

- These package dimensions are within allowable dimensions of JEDEC MO-153-AC, Issue E.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs.
 Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
- Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

M20.173
20 LEAD THIN SHRINK SMALL OUTLINE PLASTIC PACKAGE

| | INCHES | | MILLIMETERS | | |
|--------|-----------|--------|-------------|------|-------|
| SYMBOL | MIN | MAX | MIN | MAX | NOTES |
| Α | - | 0.047 | - | 1.20 | - |
| A1 | 0.002 | 0.006 | 0.05 | 0.15 | - |
| A2 | 0.031 | 0.051 | 0.80 | 1.05 | - |
| b | 0.0075 | 0.0118 | 0.19 | 0.30 | 9 |
| С | 0.0035 | 0.0079 | 0.09 | 0.20 | - |
| D | 0.252 | 0.260 | 6.40 | 6.60 | 3 |
| E1 | 0.169 | 0.177 | 4.30 | 4.50 | 4 |
| е | 0.026 BSC | | 0.65 BSC | | - |
| Е | 0.246 | 0.256 | 6.25 | 6.50 | - |
| L | 0.0177 | 0.0295 | 0.45 | 0.75 | 6 |
| N | 20 | | 20 | | 7 |
| α | 0° | 80 | 00 | 80 | - |

Rev. 1 6/98

All Intersil U.S. products are manufactured, assembled and tested utilizing ISO9000 quality systems. Intersil Corporation's quality certifications can be viewed at www.intersil.com/design/quality

Intersil products are sold by description only. Intersil Corporation reserves the right to make changes in circuit design, software and/or specifications at any time without notice. Accordingly, the reader is cautioned to verify that data sheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

For information regarding Intersil Corporation and its products, see www.intersil.com